Form PTD-1595 (Rev. 08/05) OMB No. 0851-0027 (exp. 0/30/2008)  09-05-2007  U.S. DEPARTMENT OF COMMUNITEENT OF COMUNITEENT OF COMMUNITEENT OF COMUNITEENT	ERCE
To the Director of the U.S. Patent.  103441983    Image: Security Agreement  2. Name and address of receiving party(ies)    Additional name(s) of conveying party(ies) attached?  Yes    X  2. Name and address of receiving party(ies)    Additional name(s) of conveying party(ies) attached?  Yes    X  2. Name and address of receiving party(ies)    Name:  Sony Corporation    Internal Address:  Internal Address:    Street Address:  Street Address:    1.7.1 Konan  Imato-Ku, Tokyo    Minato-Ku, Tokyo  108-0075    JAPAN  City:    Government Interest Assignment  Joint Research Agreement    Executive Order 9424, Confirmatory License  City:    Other  Zip:    4. Application or patent number(s):  X This document is being filed together with a new application	
To the Director of the U.S. Patent .  ad documents or the new address(es) be    1. Name of conveying party(ies):  Tsutomu Nakajima (07/26/2007), Kenji Kozakai (08/11/2007), and Koji Sakui (08/11/2007)    Additional name(s) of conveying party(ies) attached?  Yes    Yes  X No    3. Nature of conveyance/Execution Date(s):  1-7-1 Konan    Kinato-Ku, Tokyo  108-0075    X Assignment  Merger    Change of Name  State:    Government Interest Assignment  State:    Country:  Zip:    Other  Address(s)    4. Application or patent number(s):  X	
1. Name of conveying party(ies):  2. Name and address of receiving party(ies)    Tsutomu Nakajima (07/26/2007), Kenji Kozakai  Name:	ow.
(08/11/2007), and Koji Sakui (08/11/2007)  Name:	
Additional name(s) of conveying party(ies) attached?  Yes  X  No    Street Address:  1-7-1 Konan    Minato-Ku, Tokyo  108-0075    JAssignment  Merger  Change of Name    Security Agreement  Joint Research Agreement  City:    Government Interest Assignment  State:  Country:    Executive Order 9424, Confirmatory License  Country:  Zip:    Other  Additional name(s) & address(es)  Yes  No    4. Application or patent number(s):  X  This document is being filed together with a new application	
Execution Date(s):  in parentheses after inventor name  Minato-Ku, Tokyo    X Assignment  Merger  Change of Name  JaPAN    Security Agreement  Joint Research Agreement  City:	<u> </u>
Government Interest Assignment  State:    Executive Order 9424, Confirmatory License  Country:    Other  Additional name(s) & address(es)    4. Application or patent number(s):  X	
Executive Order 9424, Confirmatory License  Country:  Zip:    Other  Additional name(s) & address(es)  Yes  X    4. Application or patent number(s):  X  This document is being filed together with a new application	
Other  Additional name(s) & address(es)  Yes  X    4. Application or patent number(s):  X  This document is being filed together with a new application	
4. Application or patent number(s):  X	
A. Patent Application No.(s) B. Patent No.(s)	۱.
Additional numbers attached?	
5. Name and address to whom correspondence concerning document should be mailed:  6. Total number of applications and patents involved:  1	]
Name: Ronald P. Kananen RADER, FISHMAN & GRAUER PLLC 7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00	
Internal Address: Atty. Dkt.: SON-3825 Authorized to be charged by credit card	
Street Address: 1233 20th Street, N.W.	
Suite 501 Enclosed	
None required (government interest not affectin	ı title)
City: Washington 8. Payment Information	
State: DC Zip: 20036 a. Credit Card Last 4 Numbers	
Phone Number: (202) 955-3750 Expiration Date	
Fax Number:    (202) 955-3751    b. Deposit Account Number    18-0013	
Email Address:rpk@raderfishman.com Authorized User Name Ronald P. Kananen	
9. Signature: August 27, 2007 Date	
DBYRNE 00000047 100013 11892738	3
40.00 DA	3

PATENT REEL: 019793 FRAME: 0483

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in NONVOLATILE SEMICONDUCTOR MEMORY DEVICE AND WRITING METHOD

## THEREOF

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my na and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be gran therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable considerati the receipt and sufficienc of which are hereby acknowledged. I, as a sole or joint inventor as indicated below, by

hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Let Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all prio rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convent Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of Ame adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favo ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invent applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and law papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissu reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and docum relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known accessible to me and will testify as to the same in any interference or litigation related thereto; "

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into w would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing da this application in the spaces that follow: Serial Number: \_\_\_\_\_\_, Filing Date:\_\_\_\_\_\_.

.

This assignment executed on the dates indicated below.

Tsutomu NAKAJIMA

Name of first or sole inventor

Execution date of U.S. Patent Applic

Tokyo, Japan

Residence of first or sole inventor

<u>Tsutomu Nakajima</u> Signature of first or sole inventor

July 26, 2007 Date of this assign

PATENT REEL: 019793 FRAME: 0484

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Name of second inventor	Execution date of U.S. Patent Applica
Tokyo, Japan	
Residence of second inventor	
Kenjî Prozokar	Aug. 11,2007
Signature of second inventor	Date of this assignment
Koji SAKUI	
Name of third inventor	Execution date of U.S. Patent Applica
Tokyo, Japan	
Residence of third inventor	
Ani Salani	august 11, 2007
Signature of third inventor	Date of this assignr
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Name of fourth inventor	Execution date of U.S. Patent Applica
Residence of fourth inventor	
Signature of fourth inventor	Date of this assign
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Name of fifth inventor	Execution date of U.S. Patent Applic
Residence of fifth inventor	······································
	· ·
Signature of fifth inventor	Date of this assign

RECORDED: 08/27/2007

20.

Kenji KOZAKAI

PATENT REEL: 019793 FRAME: 0485